

Low Skew CMOS PLL Clock Driver

MC88915

The MC88915 Clock Driver utilizes phase-locked loop technology to lock its low skew outputs' frequency and phase onto an input reference clock. It is designed to provide clock distribution for high performance PC's and workstations.

The PLL allows the high current, low skew outputs to lock onto a single clock input and distribute it with essentially zero delay to multiple components on a board. The PLL also allows the MC88915 to multiply a low frequency input clock and distribute it locally at a higher (2X) system frequency. Multiple 88915's can lock onto a single reference clock, which is ideal for applications when a central system clock must be distributed synchronously to multiple boards (see Figure 7).

Five "Q" outputs (Q0–Q4) are provided with less than 500 ps skew between their rising edges. The Q5 output is inverted (180° phase shift) from the "Q" outputs. The 2X_Q output runs at twice the "Q" output frequency, while the Q/2 runs at 1/2 the "Q" frequency.

The VCO is designed to run optimally between 20 MHz and the 2X_Q Fmax specification. The wiring diagrams in Figure 5 detail the different feedback configurations which create specific input/output frequency relationships. Possible frequency ratios of the "Q" outputs to the SYNC input are 2:1, 1:1, and 1:2.

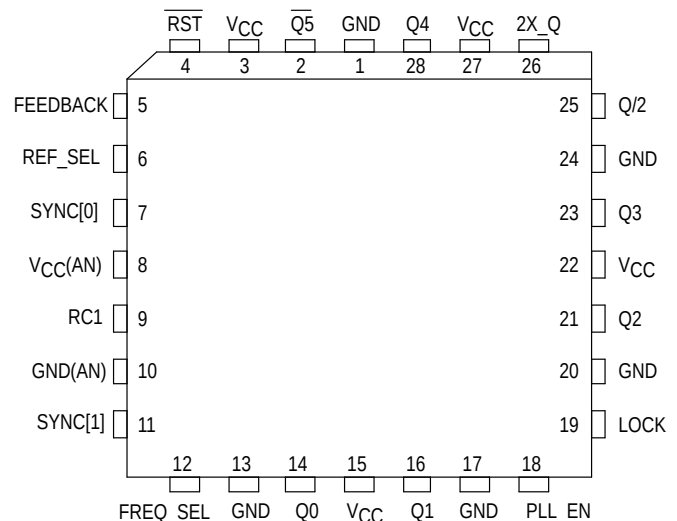
The FREQ_SEL pin provides one bit programmable divide-by in the feedback path of the PLL. It selects between divide-by-1 and divide-by-2 of the VCO before its signal reaches the internal clock distribution section of the chip (see the block diagram on page 2). In most applications FREQ_SEL should be held high (+1). If a low frequency reference clock input is used, holding FREQ_SEL low (+2) will allow the VCO to run in its optimal range (>20 MHz).

In normal phase-locked operation the PLL_EN pin is held high. Pulling the PLL_EN pin low disables the VCO and puts the 88915 in a static "test mode". In this mode there is no frequency limitation on the input clock, which is necessary for a low frequency board test environment. The second SYNC input can be used as a test clock input to further simplify board-level testing (see detailed description on page 11).

A lock indicator output (LOCK) will go high when the loop is in steady-state phase and frequency lock. The LOCK output will go low if phase-lock is lost or when the PLL_EN pin is low. Under certain conditions the lock output may remain low, even though the part is phase-locked. Therefore the LOCK output signal should not be used to drive any active circuitry; it should be used for passive monitoring or evaluation purposes only.

Features

- Five Outputs (Q0–Q4) with Output–Output Skew < 500 ps each being phase and frequency locked to the SYNC input
- The phase variation from part-to-part between the SYNC and FEEDBACK inputs is less than 550 ps (derived from the t_{PD} specification, which defines the part-to-part skew)
- Input/Output phase-locked frequency ratios of 1:2, 1:1, and 2:1 are available
- Input frequency range from 5MHz – 2X_Q FMAX spec
- Additional outputs available at 2X and +2 the system "Q" frequency. Also a Q (180° phase shift) output available
- All outputs have ± 36 mA drive (equal high and low) at CMOS levels, and can drive either CMOS or TTL inputs. All inputs are TTL-level compatible
- Test Mode pin (PLL_EN) provided for low frequency testing. Two selectable CLOCK inputs for test or redundancy purposes



28-Lead Pinout (Top View)

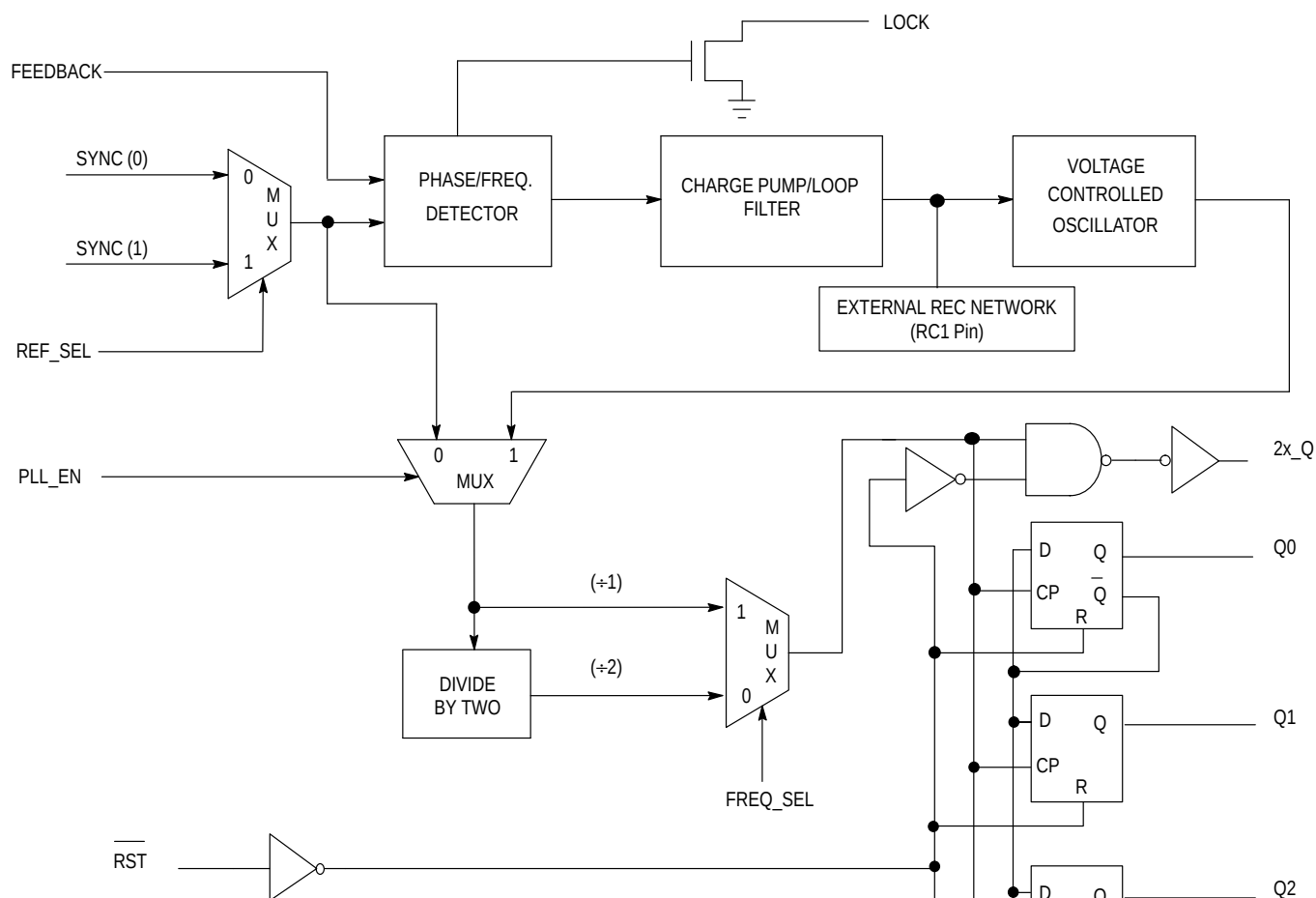
FN SUFFIX
PLASTIC PLCC
CASE 776-02

ORDERING INFORMATION

MC88915FN55 PLCC
MC88915FN70 PLCC

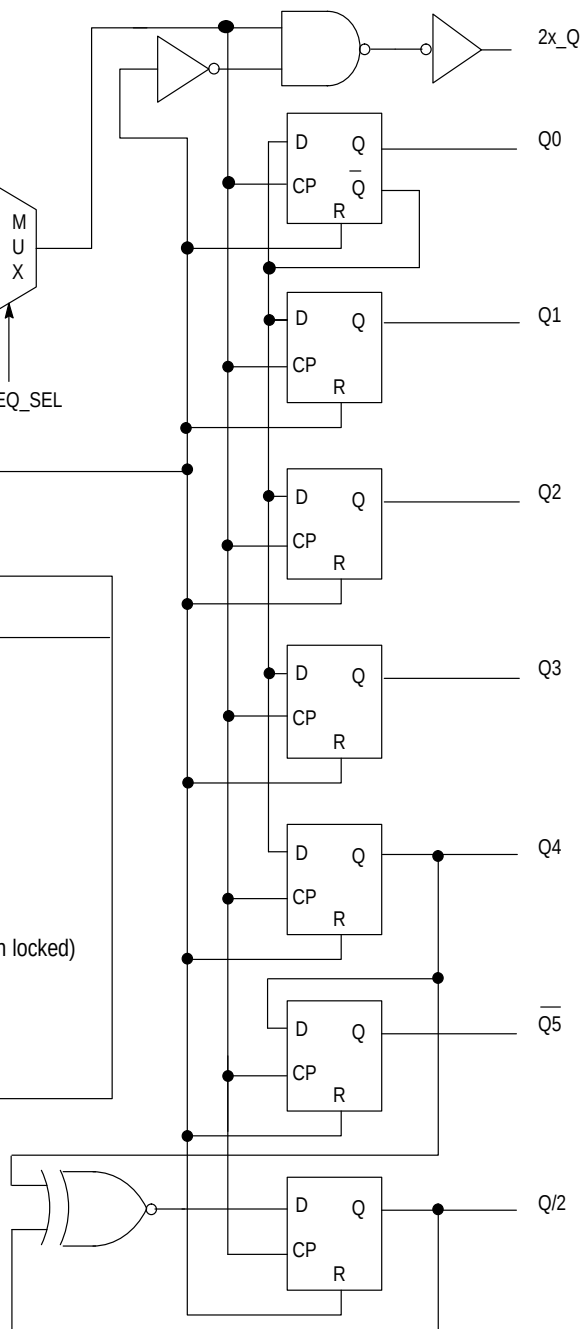


MC88915



PIN SUMMARY

Pin Name	Num	I/O	Function
SYNC[0]	1	Input	Reference clock input
SYNC[1]	1	Input	Reference clock input
REF_SEL	1	Input	Chooses reference between sync[0] & Sync[1]
FREQ_SEL	1	Input	Selects Q output frequency
FEEDBACK	1	Input	Feedback input to phase detector
RC1	1	Input	Input for external RC network
Q(0-4)	5	Output	Clock output (locked to sync)
Q5	1	Output	Inverse of clock output
2x_Q	1	Output	2 x clock output (Q) frequency (synchronous)
Q/2	1	Output	Clock output(Q) frequency $\div 2$ (synchronous)
LOCK	1	Output	Indicates phase lock has been achieved (high when locked)
RST	1	Input	Asynchronous reset (active low)
PLL_EN	1	Input	Disables phase- <u>lock</u> for low freq. testing
VCC,GND	11		Power and ground pins (note pins 8, 10 are "quiet" supply pins for internal logic only)



MC88915 Block Diagram

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND; $T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$, $V_{CC} = 5.0\text{V} \pm 5\%$)

Symbol	Parameter	Test Conditions	V_{CC} V	Guaranteed Limit	Unit
V_{IH}	Minimum High-Level Input Voltage	$V_{out} = 0.1\text{ V}$ or $V_{CC} - 0.1\text{ V}$	4.75 5.25	2.0 2.0	V
V_{IL}	Maximum Low-Level Input Voltage	$V_{out} = 0.1\text{ V}$ or $V_{CC} - 0.1\text{ V}$	4.75 5.25	0.8 0.8	V
V_{OH}	Minimum High-Level Output Voltage	$V_{in} = V_{IH}$ or V_{IL} $I_{OH} = -36\text{ mA}$ ¹	4.75 5.25	4.01 4.51	V
V_{OL}	Maximum Low-Level Output Voltage	$V_{in} = V_{IH}$ or V_{IL} $I_{OL} = 36\text{ mA}$ ¹	4.75 5.25	0.44 0.44	V
I_{in}	Maximum Input Leakage Current	$V_I = V_{CC}$ or GND	5.25	± 1.0	μA
I_{CCT}	Maximum I_{CC} /Input	$V_I = V_{CC} - 2.1\text{ V}$	5.25	1.5 ²	mA
I_{OLD}	Minimum Dynamic Output Current ³	$V_{OLD} = 1.0\text{V Max}$	5.25	88	mA
I_{OHD}		$V_{OHD} = 3.85\text{ V Max}$	5.25	-88	mA
I_{CC}	Maximum Quiescent Supply Current (per Package)	$V_I = V_{CC}$ or GND	5.25	1.0	mA

1. I_{OL} and I_{OH} are 12mA and -12mA respectively for the LOCK output.

2. The PLL_EN input pin is not guaranteed to meet this specification.

3. Maximum test duration is 2.0ms, one output loaded at a time.

CAPACITANCE AND POWER SPECIFICATIONS

Symbol	Parameter	Typical Values	Unit	Conditions
C_{IN}	Input Capacitance	4.5	pF	$V_{CC} = 5.0\text{ V}$
C_{PD}	Power Dissipation Capacitance	40	pF	$V_{CC} = 5.0\text{ V}$
PD_1	Power Dissipation @ 33MHz with 50 Ω Thevenin Termination	15 mW/Output 120 mW/Device	mW	$V_{CC} = 5.0\text{ V}$ $T = 25^\circ\text{C}$
PD_2	Power Dissipation @ 33MHz with 50 Ω Parallel Termination to GND	37.5 mW/Output 300 mW/Device	mW	$V_{CC} = 5.0\text{ V}$ $T = 25^\circ\text{C}$

SYNC INPUT TIMING REQUIREMENTS

Symbol	Parameter	Min		Max	Unit
t_{RISE}, t_{FALL}	Maximum Rise and Fall times, (SYNC Inputs: From 0.8V – 2.0V)	–		3.0	ns
t_{CYCLE}	Input Clock Period (SYNC Inputs)	FN55 36	FN70 28.5	200 ¹	ns
Duty Cycle	Input Duty Cycle (SYNC Inputs)	50% $\pm 25\%$			

1. Information in Fig. 5 and in the "General AC Specification Notes", Note #3 describes this specification and its actual limits depending on the application.

FREQUENCY SPECIFICATIONS ($T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$, $V_{CC} = 5.0\text{V} \pm 5\%$, $C_L = 50\text{pF}$)

Symbol	Parameter	Guaranteed Minimum		Unit
		MC88915FN55	MC88915FN70	
f_{max} ¹	Maximum Operating Frequency (2X_Q Output)	55	70	MHz
	Maximum Operating Frequency (Q0–Q4,Q5 Output)	27.5	35	MHz

1. Maximum Operating Frequency is guaranteed with the part in a phase-locked condition, and all outputs loaded at 50 pF.

AC ELECTRICAL CHARACTERISTICS ($T_A = 0^\circ\text{C}$ to $+70^\circ\text{C}$, $V_{CC} = 5.0\text{V} \pm 5\%$, $C_L = 50\text{pF}$)

Symbol	Parameter	Min	Max	Unit
t _{RISE} , t _{FALL} (Outputs)	Rise and Fall Times, all Outputs Into a 50 pF, 500 Ω Load (Between 0.2V _{CC} and 0.8V _{CC})	1.0	2.5	ns
t _{RISE} , t _{FALL} ³ (2X_Q Output)	Rise and Fall Time, 2X_Q Output Into a 20 pF Load With Termination specified in note 2 (Between 0.8 V and 2.0 V)	0.5	1.6	ns
t _{Pulse Width} ³ (Q0,Q1,Q3,Q4, Q5,Q/2)	Output Pulse Width (Q0, Q1, Q3, Q4, Q5, Q/2 @V _{CC} /2)	0.5t _{CYCLE} – 0.5	0.5t _{CYCLE} + 0.5	ns
		t _{CYCLE} = 1/Freq. at which the “Q”		
		Outputs are running		
t _{Pulse Width} ³ (Q2 only)	Output Pulse Width (Q2 Output @ V _{CC} /2)	0.5t _{CYCLE} – 0.6	0.5t _{CYCLE} + 0.6	
t _{Pulse Width} ³ (2X_Q Output)	Output Pulse Width (2X_Q Output @ 1.5 V) (See AC Note 2)	0.5t _{CYCLE} – 0.5	0.5t _{CYCLE} + 0.5	ns
t _{Pulse Width} ³ (2X_Q Output)	Output Pulse Width (2X_Q Output @ V _{CC} /2)	0.5t _{CYCLE} – 1.0	0.5t _{CYCLE} + 1.0	ns
t _{PD} ³ (Sync–Feedback)	SYNC input to feedback delay (meas. @ SYNC0 or 1 and FEEDBACK input pins) (See General AC Specification note 4 and Fig. 2 for explanation)	(470kΩ From RC1 to An.V _{CC})		ns
		–1.05	–0.50	
		(470kΩ From RC1 to An.GND)		
		+1.25	+3.25	
t _{SKEW_r} ^{1,3} (Rising)	Output–to–Output Skew Between Outputs Q0 – Q4, Q/2 (Rising Edges Only)	–	500	ps
t _{SKEW_f} ^{1,3} (Falling)	Output–to–Output Skew Between Outputs Q0 – Q4 (Falling Edges Only)	–	750	ps
t _{SKEW_{all}} ^{1,3}	Output–to–Output Skew Between Outputs 2X_Q, Q/2, Q0 – Q4 Rising, Q5 Falling	–	750	ps
t _{LOCK}	Time Required to acquire ² Phase–Lock from time SYNC Input Signal is Received.	1	10	ms
t _{PHL} (Reset – Q)	Propagation Delay, RST to Any Output (High–Low)	1.5	13.5	ns

1. Under equally loaded conditions, $C_L \leq 50\text{pF}$ ($\pm 2\text{pF}$), and at a fixed temperature and voltage.

2. With V_{CC} fully powered-on and an output properly connected to the FEEDBACK pin. t_{LOCK} Max. is with $C1 = 0.1\mu\text{F}$, t_{LOCK} Min is with $C1 = 0.01\mu\text{F}$.

3. These specifications are not tested, they are guaranteed by statistical characterization. See General AC Specification note 1.

RESET TIMING REQUIREMENTS ¹

Symbol	Parameter	Minimum	Unit
$t_{REC, RST}$ to SYNC	Reset Recovery Time rising RST edge to falling SYNC edge	9.0	ns
$t_{W, RST}$ LOW	Minimum Pulse Width, RST input LOW	5.0	ns

1. These reset specs are valid only when PLL_EN is LOW and the part is in Test mode (not in phase-lock)

General AC Specification Notes

1. Several specifications can only be measured when the MC88915 is in phase-locked operation. It is not possible to have the part in phase-lock on ATE (automated test equipment). Statistical characterization techniques were used to guarantee those specifications which cannot be measured on the ATE. MC88915 units were fabricated with key transistor properties intentionally varied to create a 14 cell designed experimental matrix. IC performance was characterized over a range of transistor properties (represented by the 14 cells) in excess of the expected process variation of the wafer fabrication area. Response Surface Modeling (RSM) techniques were used to relate IC performance to the CMOS transistor properties over operation voltage and temperature. IC Performance to each specification and fab variation were used in conjunction with Yield Surface Modeling™ (YSM™) methodology to set performance limits of ATE testable specifications within those which are to be guaranteed by

statistical characterization. In this way all units passing the ATE test will meet or exceed the non-tested specifications limits.

2. These two specs (tRISE/FALL and tPULSE Width 2X_Q output) guarantee that the MC88915 meets the 25 MHz 68040 P-Clock input specification (at 50 MHz). For these two specs to be guaranteed by Motorola, the termination scheme shown below in Figure 1 must be used.
3. The wiring Diagrams and written explanations in Figure 5 demonstrate the input and output frequency relationships for three possible feedback configurations. The allowable SYNC input range for each case is also indicated. There are two allowable SYNC frequency ranges, depending whether FREQ_SEL is high or low. Although not shown, it is possible to feed back the Q5 output, thus creating a 180° phase shift between the SYNC input and the "Q" outputs. Table 1 below summarizes the allowable SYNC frequency range for each possible configuration.

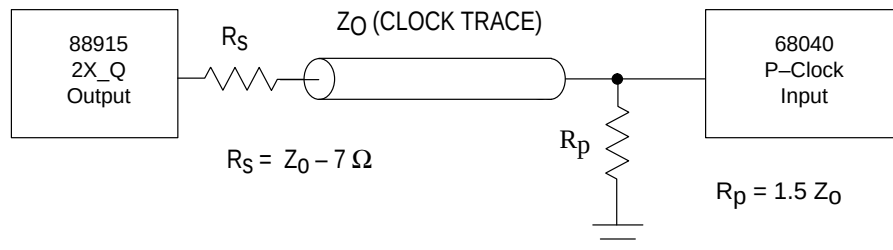


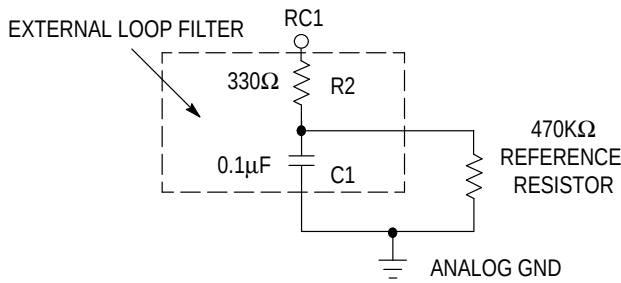
Figure 1. MC68040 P-Clock Input Termination Scheme

FREQ_SEL Level	Feedback Output	Allowable SYNC Input Frequency Range (MHZ)	Corresponding VCO Frequency Range	Phase Relationships of the "Q" Outputs to Rising SYNC Edge
HIGH	Q/2	5 to (2X_Q FMAX Spec)/4	20 to (2X_Q FMAX Spec)	0°
HIGH	Any "Q" (Q0–Q4)	10 to (2X_Q FMAX Spec)/2	20 to (2X_Q FMAX Spec)	0°
HIGH	Q5	10 to (2X_Q FMAX Spec)/2	20 to (2X_Q FMAX Spec)	180°
HIGH	2X_Q	20 to (2X_Q FMAX Spec)	20 to (2X_Q FMAX Spec)	0°
LOW	Q/2	2.5 to (2X_Q FMAX Spec)/8	20 to (2X_Q FMAX Spec)	0°
LOW	Any "Q" (Q0–Q4)	5 to (2X_Q FMAX Spec)/4	20 to (2X_Q FMAX Spec)	0°
LOW	Q5	5 to (2X_Q FMAX Spec)/4	20 to (2X_Q FMAXSpec)	180°
LOW	2X_Q	10 to (2X_Q FMAX Spec)/2	20 to (2X_Q FMAXSpec)	0°

Table 1. Allowable SYNC Input Frequency Ranges for Different Feedback Configurations.

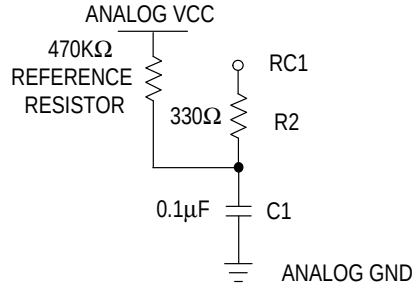
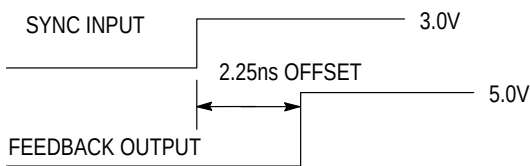
4. A 1 MΩ resistor tied to either Analog V_{CC} or Analog GND as shown in Figure 2 is required to ensure no jitter is present on the MC88915 outputs. This technique causes a phase offset between the SYNC input and the output connected to the FEEDBACK input, measured at the input pins. The t_{PD} spec describes how this offset varies with process, temperature, and voltage. The specs were arrived at by measuring the phase relationship for the 14

lots described in note 1 while the part was in phase-locked operation. The actual measurements were made with a 10 MHz SYNC input (1.0 ns edge rate from 0.8 V – 2.0 V) with the Q/2 output fed back. The phase measurements were made at 1.5 V. The Q/2 output was terminated at the FEEDBACK input with 100Ω to V_{CC} and 100 Ω to ground.



With the 470KΩ resistor tied in this fashion, the t_{PD} specification measured at the input pins is:

$$t_{PD} = 2.25\text{ns} \pm 1.0\text{ns}$$



With the 470KΩ resistor tied in this fashion, the t_{PD} specification measured at the input pins is:

$$t_{PD} = -0.775\text{ns} \pm 0.275\text{ns}$$

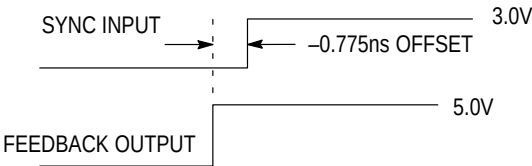


Figure 2. Depiction of the Fixed SYNC to Feedback Offset (t_{PD}) Which is Present When a 470KΩ Resistor is Tied to VCC or Ground

5. The t_{SKEW} specification guarantees that the rising edges of outputs Q/2, Q0, Q1, Q2, Q3, and Q4 will always fall within a 500ps window within one part. However, if the relative position of each output within this window is not specified, the 500 ps window must be added to each side of the t_{PD} specification limits to calculate the total part-to-part skew. For this reason the absolute

distribution of these outputs are provided in table 2. When taking the skew data, Q0 was used as a reference, so all measurements are relative to this output. The information in Table 2 is derived from measurements taken from the 14 process lots described in Note 1, over the temperature and voltage range.

Output	- (ps)	+ (ps)
Q0	0	0
Q1	-72	40
Q2	-44	276
Q3	-40	255
Q4	-274	-34
Q/2	-16	250
2X_Q	-633	-35

Table 2. Relative Positions of Outputs Q/2, Q0-Q4, 2X_Q, Within the 500ps t_{SKEW} Spec Window

6. Calculation of Total Output-to-Skew between multiple parts (Part-to-Part skew)

By combining the t_{PD} specification and the information in Note 5, the worst case output-to-output skew between multiple 88915's connected in parallel can be calculated. This calculation assumes that all parts have a common SYNC input clock with equal delay of that input signal to each part. This skew value is valid at the 88915 output pins only (equally loaded), it does not include PCB trace delays due to varying loads.

With a $1M\Omega$ resistor tied to analog V_{CC} as shown in note 4, the t_{PD} spec. limits between SYNC and the Q/2 output (connected to the FEEDBACK pin) are $-1.05ns$ and $-0.5ns$. To calculate the skew of any given output between two or more parts, the absolute value of the distribution of that output given in table 2 must be subtracted and added to the lower and upper t_{PD} spec limits respectively. For output Q2, $[276 - (-44)] = 320ps$ is the absolute value of the distribution. Therefore $[-1.05ns$

$-0.32ns] = -1.37ns$ is the lower t_{PD} limit, and $[-0.5ns + 0.32ns] = -0.18ns$ is the upper limit. Therefore the worst case skew of output Q2 between any number of parts is $[(-1.37) - (-0.18)] = 1.19ns$. Q2 has the worst case skew distribution of any output, so $1.2ns$ is the absolute worst case output-to-output skew between multiple parts.

7. Note 4 explains that the t_{PD} specification was measured and is guaranteed for the configuration of the Q/2 output connected to the FEEDBACK pin and the SYNC input running at 10MHz. The fixed offset (t_{PD}) as described above has some dependence on the input frequency and at what frequency the VCO is running. The graphs of Figure 3 demonstrate this dependence.

The data presented in Figure 3 is from devices representing process extremes, and the measurements were also taken at the voltage extremes ($V_{CC} = 5.25V$ and $4.75V$). Therefore the data in Figure 3 is a realistic representation of the variation of t_{PD} .

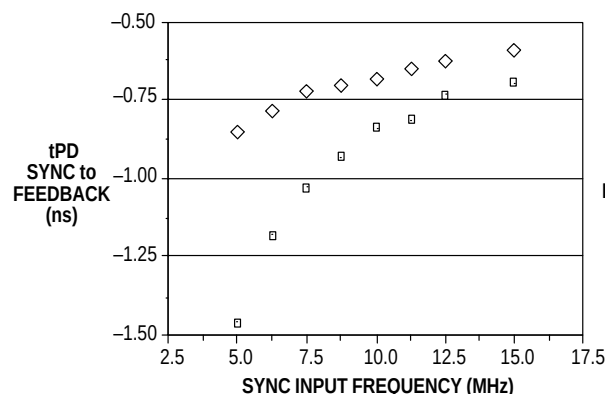


Figure 3a.

t_{PD} versus Frequency Variation for Q/2 Output Fed Back, Including Process and Voltage Variation @ 25°C (With $1M\Omega$ Resistor Tied to Analog V_{CC})

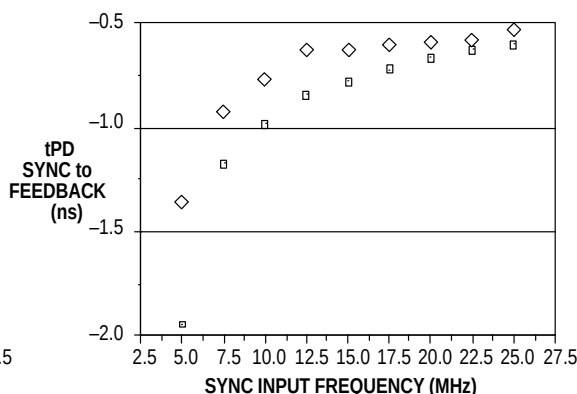


Figure 3b.

t_{PD} versus Frequency Variation for Q4 Output Fed Back, Including Process and Voltage Variation @ 25°C (With $1M\Omega$ Resistor Tied to Analog V_{CC})

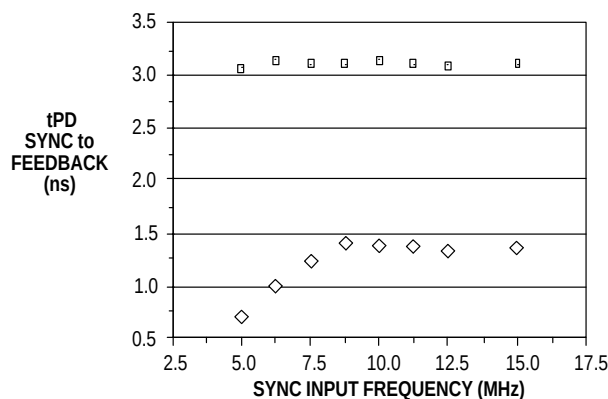


Figure 3c.

t_{PD} versus Frequency Variation for Q/2 Output Fed Back, Including Process and Voltage Variation @ 25°C (With $1M\Omega$ Resistor Tied to Analog GND)

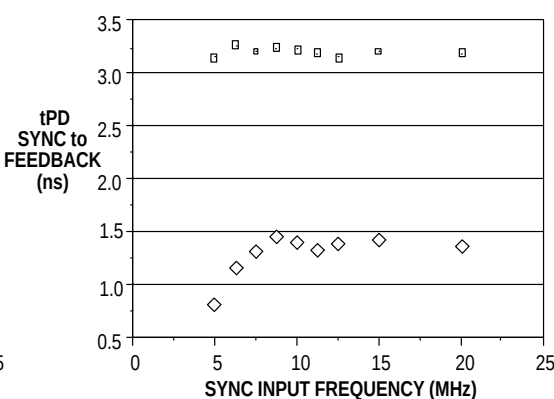


Figure 3d.

t_{PD} versus Frequency Variation for Q4 Output Fed Back, Including Process and Voltage Variation @ 25°C (With $1M\Omega$ Resistor Tied to Analog GND)

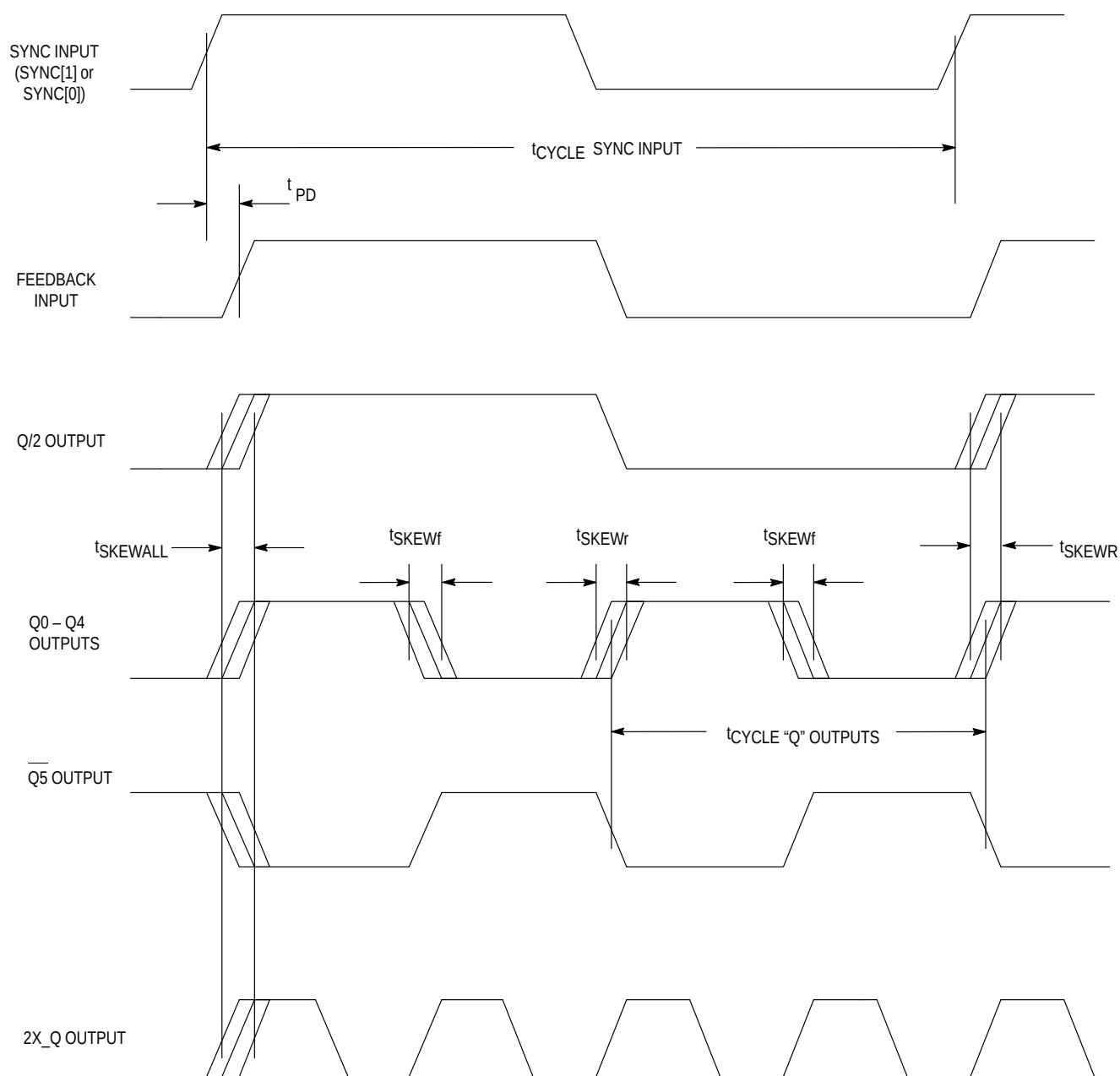
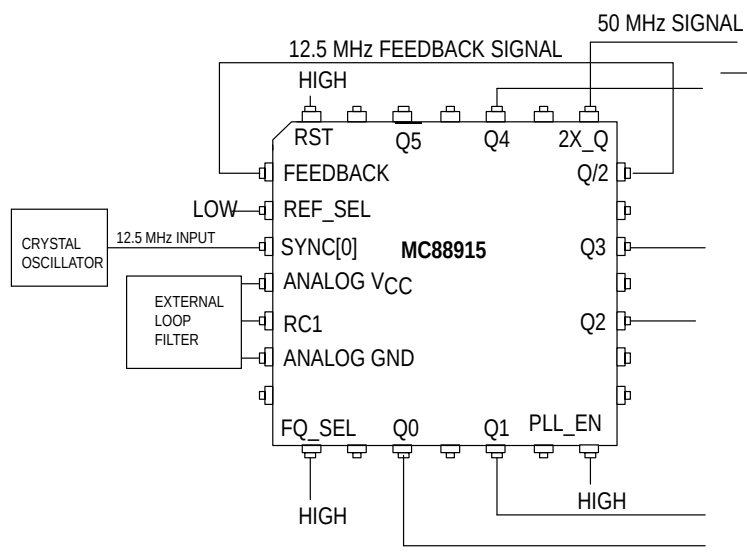


Figure 4. Output / Input Switching Waveforms and Timing Diagrams

(These waveforms represent the hook-up configuration of Figure 5a on page 9)

Timing Notes:

- The MC88915 aligns rising edges of the FEEDBACK input and SYNC input, therefore the SYNC input does not require a 50% duty cycle.
- All skew specs are measured between the $V_{\text{CC}}/2$ crossing point of the appropriate output edges. All skews are specified as 'windows', not as a $\pm$ deviation around a center point.
- If a "Q" output is connected to the FEEDBACK input (this situation is not shown), the "Q" output frequency would match the SYNC input frequency, the 2X_Q output would run at twice the SYNC frequency, and the Q/2 output would run at half the SYNC frequency.



1:2 Input to "Q" Output Frequency Relationship

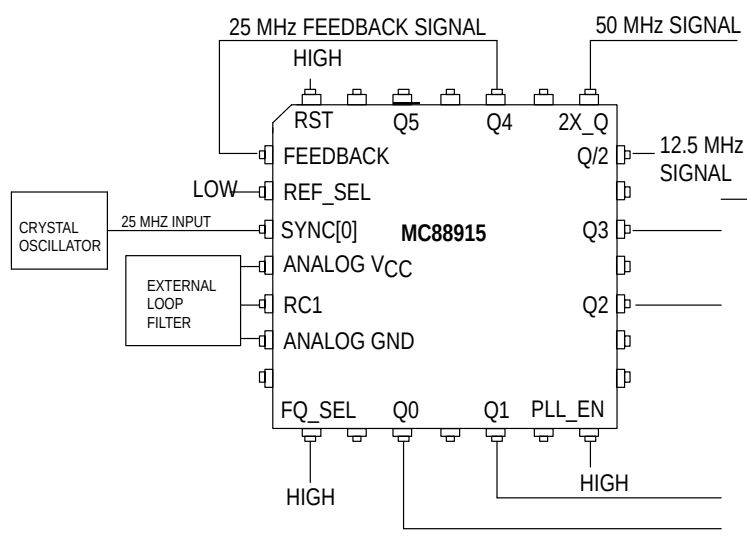
In this application, the Q/2 output is connected to the FEEDBACK input. The internal PLL will line up the positive edges of Q/2 and SYNC, thus the Q/2 frequency will equal the SYNC frequency. The "Q" outputs (Q0–Q4, Q5) will always run at 2X the Q/2 frequency, and the 2X_Q output will run at 4X the Q/2 frequency.

25MHz
"Q"
CLOCK
OUTPUTS

Allowable Input Frequency Range:

5MHz to $(2X_Q \text{ FMAX Spec})/4$ (for FREQ_SEL HIGH)
2.5MHz to $(2X_Q \text{ FMAX Spec})/8$ (for FREQ_SEL LOW)

Figure 5a. Wiring Diagram and Frequency Relationships With Q/2 Output Feed Back



1:1 Input to "Q" Output Frequency Relationship

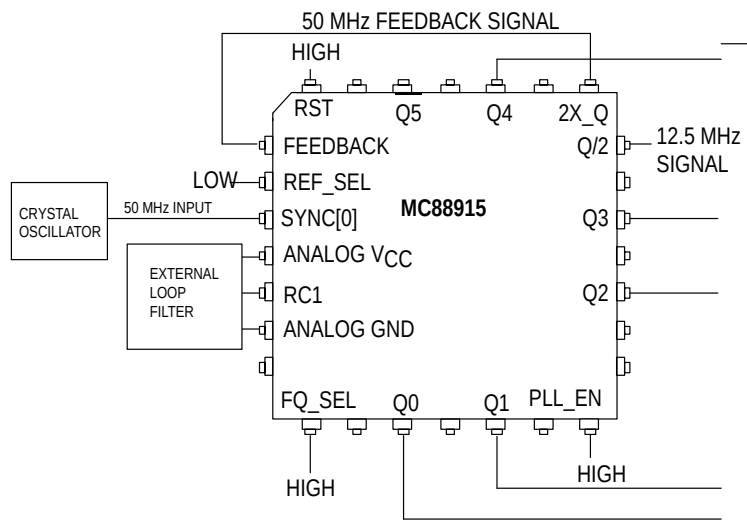
In this application, the Q4 output is connected to the FEEDBACK input. The internal PLL will line up the positive edges of Q4 and SYNC, thus the Q4 frequency (and the rest of the "Q" outputs) will equal the SYNC frequency. The Q/2 output will always run at 1/2 the "Q" frequency, and the 2X_Q output will run at 2X the "Q" frequency.

25MHz
"Q"
CLOCK
OUTPUTS

Allowable Input Frequency Range:

10MHz to $(2X_Q \text{ FMAX Spec})/2$ (for FREQ_SEL HIGH)
5MHz to $(2X_Q \text{ FMAX Spec})/4$ (for FREQ_SEL LOW)

Figure 5b. Wiring Diagram and Frequency Relationships With Q4 Output Feed Back



2:1 Input to "Q" Output Frequency Relationship

In this application, the 2X_Q output is connected to the FEEDBACK input. The internal PLL will line up the positive edges of 2X_Q and SYNC, thus the 2X_Q frequency will equal the SYNC frequency. The Q/2 output will always run at 1/4 the 2X_Q frequency, and the "Q" outputs will run at 1/2 the 2X_Q frequency.

25MHz
"Q"
CLOCK
OUTPUTS

Allowable Input Frequency Range:

20MHz to $(2X_Q \text{ FMAX Spec})$ (for FREQ_SEL HIGH)
10MHz to $(2X_Q \text{ FMAX Spec})/2$ (for FREQ_SEL LOW)

Figure 5c. Wiring Diagram and Frequency Relationships with 2X_Q Output Feed Back

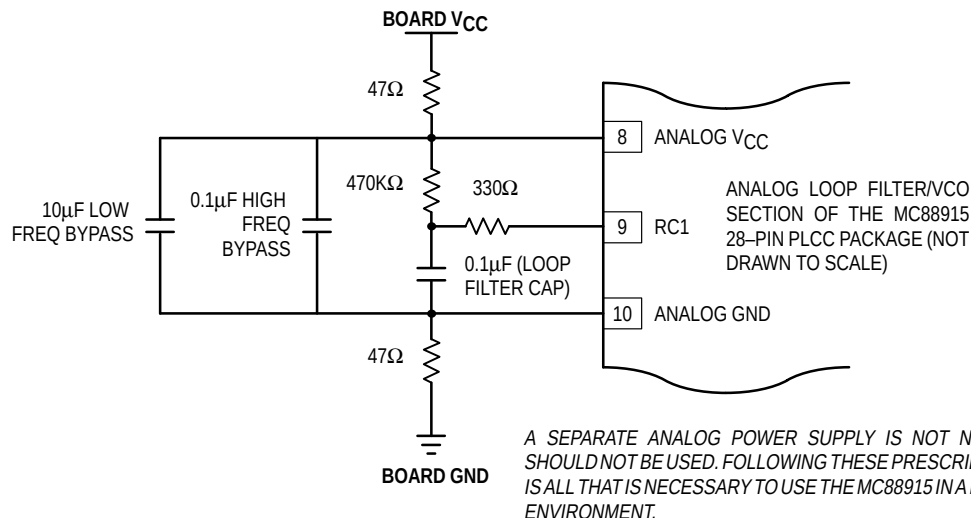


Figure 6. Recommended Loop Filter and Analog Isolation Scheme for the MC88915

Notes Concerning Loop Filter and Board Layout Issues

1. Figure 6 shows a loop filter and analog isolation scheme which will be effective in most applications. The following guidelines should be followed to ensure stable and jitter-free operation:

1a. All loop filter and analog isolation components should be tied as close to the package as possible. Stray current passing through the parasitics of long traces can cause undesirable voltage transients at the RC1 pin.

1b. The 47Ω resistors, the 10μF low frequency bypass capacitor, and the 0.1μF high frequency bypass capacitor form a wide bandwidth filter that will minimize the 88915's sensitivity to voltage transients from the system digital V_{CC} supply and ground planes. This filter will typically ensure that a 100mV step deviation on the digital V_{CC} supply will cause no more than a 100pS phase deviation on the 88915 outputs. A 250mV step deviation on V_{CC} using the recommended filter values should cause no more than a 250pS phase deviation; if a 25μF bypass capacitor is used (instead of 10μF) a 250mV V_{CC} step should cause no more than a 100pS phase deviation.

If good bypass techniques are used on a board design near components which may cause digital V_{CC} and ground noise, the above described V_{CC} step deviations should not occur at the 88915's digital V_{CC} supply. The purpose of the bypass filtering scheme shown in Figure 6

is to give the 88915 additional protection from the power supply and ground plane transients that can occur in a high frequency, high speed digital system.

1c. There are no special requirements set forth for the loop filter resistors (470K and 330Ω). The loop filter capacitor (0.1μF) can be a ceramic chip capacitor, the same as a standard bypass capacitor.

1d. The 470K reference resistor injects current into the internal charge pump of the PLL, causing a fixed offset between the outputs and the SYNC input. This also prevents excessive jitter caused by inherent PLL dead-band. If the VCO (2X_Q output) is running above 40MHz, the 470K resistor provides the correct amount of current injection into the charge pump (2–3μA). If the VCO is running below 40MHz, a 1MΩ reference resistor should be used (instead of 470K).

2. In addition to the bypass capacitors used in the analog filter of Figure 6, there should be a 0.1μF bypass capacitor between each of the other (digital) four V_{CC} pins and the board ground plane. This will reduce output switching noise caused by the 88915 outputs, in addition to reducing potential for noise in the 'analog' section of the chip. These bypass capacitors should also be tied as close to the 88915 package as possible.



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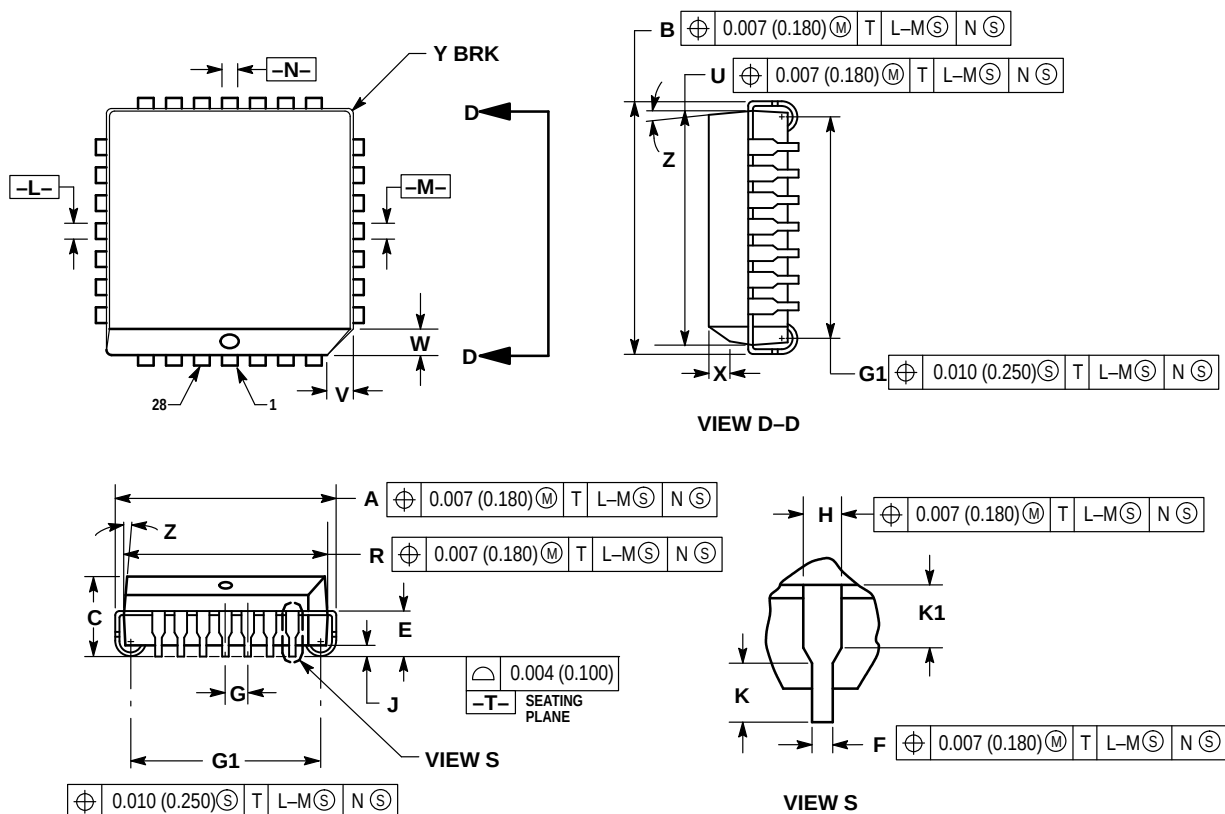
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